

MCP 16+ 16

	Components		Substrate of MCP8+8	Remark
	Tech- node, density, device	ibs file name	ibs file name	
DRAM	1ynm 8Gb LPDDR4x	h54g3xyhxx243k_05.ibs , h54g3xyhxx243k_06.ibs	LPDDR4x 1: GSD0364_R0_149FBGA_16G16G_R0_231107_dram1_149f.pkg LPDDR4x 2: GSD0364_R0_149FBGA_16G16G_R0_231107_dram2_149f.pkg	A description of the file name. P/N : H54G3XBYRHX243K *_05 : VOH = 0.5*VDDQ *_06 : VOH = 0.6 *VDDQ
NAND	32nm 4Gb SLC NAND	S34ms04g2_b_i_18_r2.ibs	NAND1: GSD0364_R0_149FBGA_16G16G_R0_231107_nand1_149f.pkg NAND2: GSD0364_R0_149FBGA_16G16G_R0_231107_nand2_149f.pkg NAND3: GSD0364_R0_149FBGA_16G16G_R0_231107_nand3_149f.pkg NAND4: GSD0364_R0_149FBGA_16G16G_R0_231107_nand4_149f.pkg	